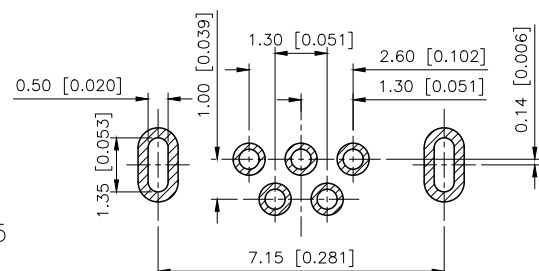
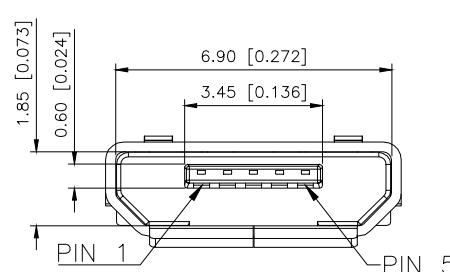
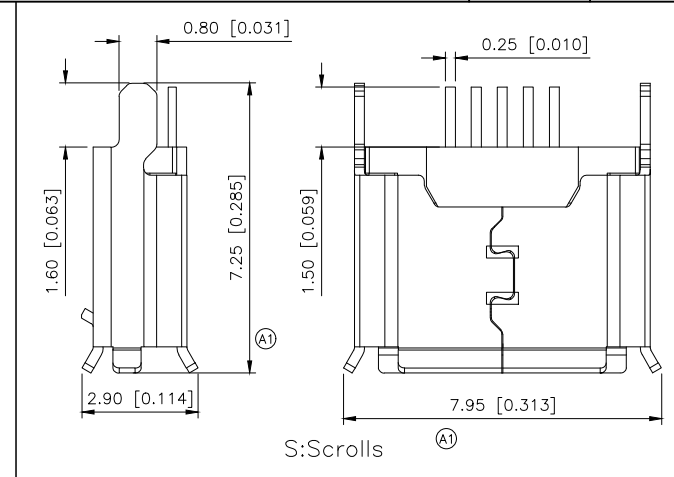
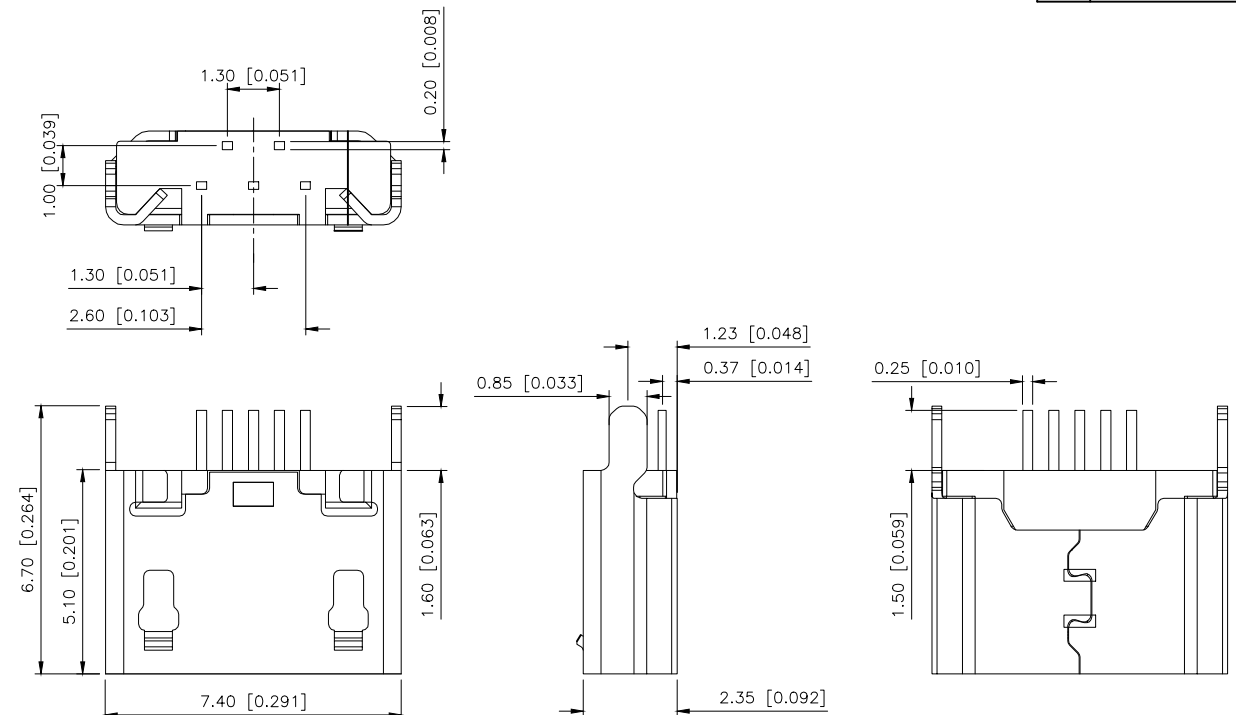


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A	(A1) x2	产品尺寸变更, 图面升级整理图面	2025.04.22	阿树



RECOMMENDED PCB LAYOUT

U255-05XX-4BH70-XS

1:AU 1U"
6:AU 30U"

T:TIN
N:NICKEL

S:SUS
S:Scrolls
F:Flat

B:Black
W:White

1:PBT
2:PA6T
3:PA9T
4:LCP

- NOTES:
- MATERIAL:
 - 1.1 HOUSING:THERMOPLASTIC FLAMMABILITY RATING UL94-0
 - 1.2 CONTACT: COPPERY ALLOY T=0.15MM
 - 1.3 SHELL: COPPERY ALLOY T=0.25MM
 - FINISH:
 - 2.1 CONTACT:1U"MIN,PLATED ON CONTACT AREA
 - G/F PLATING ON SOLDER TAIL AREA
 - 50~80U" NICKEL UNDERPLATING OVERALL
 - 2.2 SHELL:
 - 80~120U" MATTER TIN PLAING ALL
 - 50~80U" NICKEL UNDERPLATING OVERALL
 - SPECIFICATION:
 - 3.3 CURRENT RATING:0.5A(2.3.4CONTACT)/1.8A (1.5CONTACT)MAX.
 - 3.2 VOLTAGE:30 VAC
 - 3.3 TEMPERATURE RANGE:-30°C~85°C
 - 3.4 CONTACT RESISTANCE:30 MILLIONHM MAX.
 - 3.5 DIELECTRIC WITHSTANDING VOLTAGE:25OVAC R.M.S
 - 3.6 INSULATION RESISTNACE:100 MEGOHMS MIN

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAuces	



DESIGN	阿树	VIEW:	MODEL TYPE: MICRO USB
CHECKED		UNIT: mm/in	PART NO.: U255-05XX-4BH70-XS
APPROVED		SIZE: A4	DWG NO.: